



Vishay General Semiconductor

Surface Mount Ultrafast Plastic Rectifier



DO-214AA (SMB)

| PRIMARY CHARACTERISTICS | | | | | |
|--|---------------------|--|--|--|--|
| I _{F(AV)} | 2.0 A | | | | |
| V _{RRM} | 100 V, 150 V, 200 V | | | | |
| I _{FSM} | 50 A | | | | |
| t _{rr} | 20 ns | | | | |
| V _F at I _F = 2.0 A | 0.76 V | | | | |
| T _J max. | 150 °C | | | | |

FEATURES

• Oxide planar chip junction



• Low forward voltage, low power losses

· High forward surge capability

 Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

 Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC





RoHS

TYPICAL APPLICATIONS

For use in low voltage, high frequency rectifier of switching power supplies, freewheeling diodes, dc-to-dc converters or polarity protection application.

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test **Polarity:** Color band denotes cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|--|-----------------------------------|---------------|-----|-----|------|
| PARAMETER | SYMBOL | U2B | U2C | U2D | UNIT |
| Device marking code | | U2B | U2C | U2D | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 100 | 150 | 200 | V |
| Maximum average forward rectified current (fig. 1) | I _{F(AV)} | 2.0 | | | Α |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I _{FSM} | 50 | | | А |
| Operating junction and storage temperature range | T _J , T _{STG} | - 55 to + 150 | | | °C |

U2B, U2C, U2D

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|---|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 2 A$ | T _A = 25 °C | V _F ⁽¹⁾ | 0.86 | 0.90 | V |
| | | T _A = 100 °C | | 0.76 | 0.83 | |
| Reverse current | Rated V _R | T _A = 25 °C | I _R ⁽²⁾ | ı | 10 | μА |
| | | T _A = 100 °C | | 180 | 350 | |
| Reverse recovery time | $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$ | T _A = 25 °C | t _{rr} | - | 20 | ns |
| | I _F = 2.0 A, dI/dt = 50 A/µs, V _R = 30 V, I _{rr} = 0.1 I _{RM} | T _A = 25 °C | | 27 | - | |
| | | T _A = 100 °C | | 35 | - | |
| Storage charge | $I_F = 2.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$ | T _A = 25 °C | Q _{rr} | 9 | - | nC |
| | | T _A = 100 °C | | 19 | - | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 16 | - | pF |

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | |
|---|---------------------------------|-----------------|--|------|--|
| PARAMETER | SYMBOL | BOL U2B U2C U2D | | UNIT | |
| Turning the word vesictors | R _{θJA} ⁽¹⁾ | 105 | | °C/W | |
| Typical thermal resistance | R _{0JM} (1) | 18 | | | |

Note

 $^{^{(1)}}$ Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| U2D-E3/52T | 0.099 | 52T | 750 | 7" diameter plastic tape and reel | |
| U2D-E3/5BT | 0.099 | 5BT | 3200 | 13" diameter plastic tape and reel | |

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

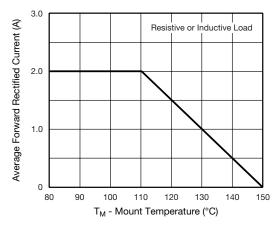


Fig. 1 - Maximum Forward Current Derating Curve

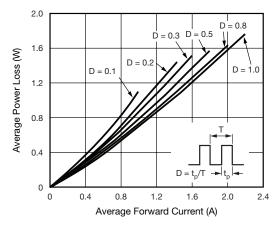


Fig. 2 - Forward Power Loss Characteristics



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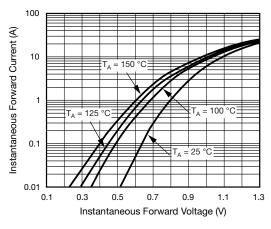


Fig. 3 - Typical Instantaneous Forward Characteristics

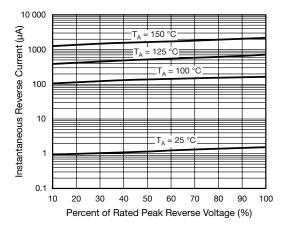


Fig. 4 - Typical Reverse Characteristics

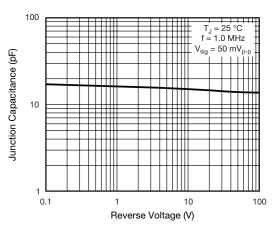


Fig. 5 - Typical Junction Capacitance

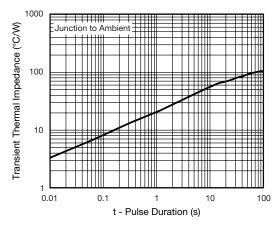


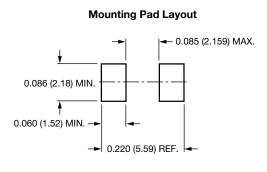
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)

Cathode Band 0.086 (2.20) 0.077 (1.95) 0.180 (4.57) 0.160 (4.06) 0.096 (2.44) 0.084 (2.13) 0.060 (1.52) 0.030 (0.76) 0.220 (5.59)

0.205 (5.21)







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